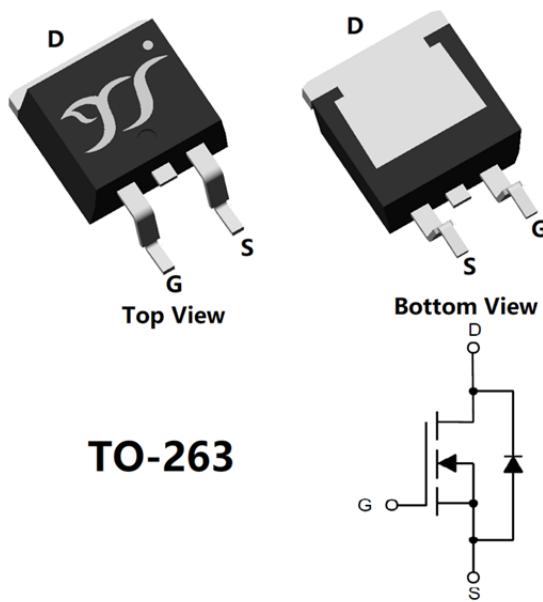


## N-Channel Enhancement Mode Field Effect Transistor



### Product Summary

- $V_{DS}$  40V
- $I_D$  164A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) <2.8mohm
- 100% EAS Tested
- 100%  $\nabla V_{DS}$  Tested

### General Description

- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free
- Part no. with suffix "Q" means AEC-Q101 qualified

### Applications

- Power switching application
- Uninterruptible power supply
- DC-DC convertor
- 12V Automotive systems

### ■ Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-source Voltage	$V_{DS}$	40	V
Gate-source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current	$I_D$	26	A
		18	
		164	
		116	
Pulsed Drain Current <sup>A</sup>	$I_{DM}$	450	A
Avalanche energy <sup>B</sup>	EAS	484	mJ
Total Power Dissipation <sup>C</sup>	$P_D$	3.5	W
		1.7	
		136	
		68	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55~+175	°C

### ■ Thermal resistance

Parameter	Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient <sup>D</sup>	$R_{\theta JA}$	35	42	°C/W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.9	1.1	



### ■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJB2D8G04HHQ	F2	YJB2D8G04H	800	/	8000	13" reel

### ■ Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
<b>Static Parameter</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$			1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$			$\pm 100$	nA
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	2	3	4	V
Static Drain-Source On-Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=50\text{A}$		2.2	2.8	$\text{m}\Omega$
Diode Forward Voltage	$V_{\text{SD}}$	$I_{\text{S}}=20\text{A}, V_{\text{GS}}=0\text{V}$		0.9	1.2	V
Gate resistance	$R_{\text{G}}$	$f=1\text{MHz}$		1.0		$\Omega$
<b>Dynamic Parameters</b>						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=1\text{MHz}$	-	3500	-	pF
Output Capacitance	$C_{\text{oss}}$		-	1000	-	
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	40	-	
<b>Switching Parameters</b>						
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=20\text{V}, I_{\text{D}}=45\text{A}$	-	42.2	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	15.4	-	
Gate-Drain Charge	$Q_{\text{gd}}$		-	9.4	-	
Reverse Recovery Charge	$Q_{\text{rr}}$	$I_{\text{F}}=30\text{A}, \text{di/dt}=150\text{A/us}$	-	40	-	nC
Reverse Recovery Time	$t_{\text{rr}}$		-	38	-	ns
Turn-on Delay Time	$t_{\text{D(on)}}$	$V_{\text{GS}}=10\text{V}, V_{\text{DD}}=20\text{V}, I_{\text{D}}=45\text{A}$ $R_{\text{GEN}}=2.2\Omega$	-	20.3	-	ns
Turn-on Rise Time	$t_{\text{r}}$		-	209	-	
Turn-off Delay Time	$t_{\text{D(off)}}$		-	25	-	
Turn-off fall Time	$t_{\text{f}}$		-	12.3	-	

- A. Repetitive rating; pulse width limited by max. junction temperature.
- B.  $T_J=25^\circ\text{C}, V_{\text{DD}}=40\text{V}, V_{\text{G}}=10\text{V}, L=2\text{mH}, I_{\text{AS}}=22\text{A}$ .
- C.  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- D. The value of  $R_{\text{GJA}}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The maximum allowed junction temperature of  $175^\circ\text{C}$ . The value in any given application depends on the user's specific board design.



## ■Typical Electrical and Thermal Characteristics Diagrams

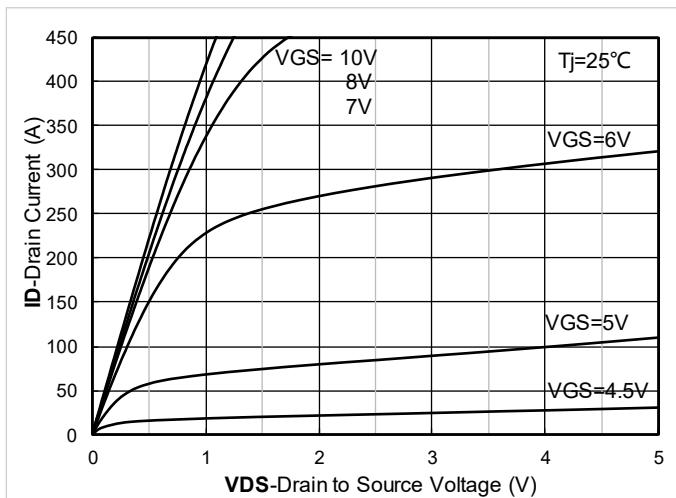


Figure 1. Output Characteristics

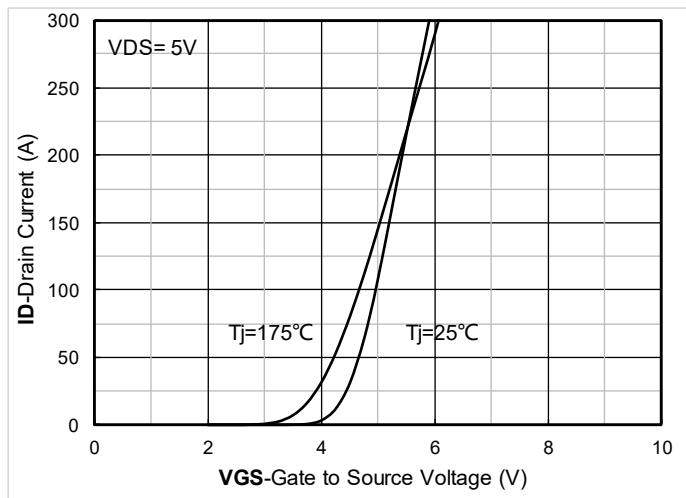


Figure 2. Transfer Characteristics

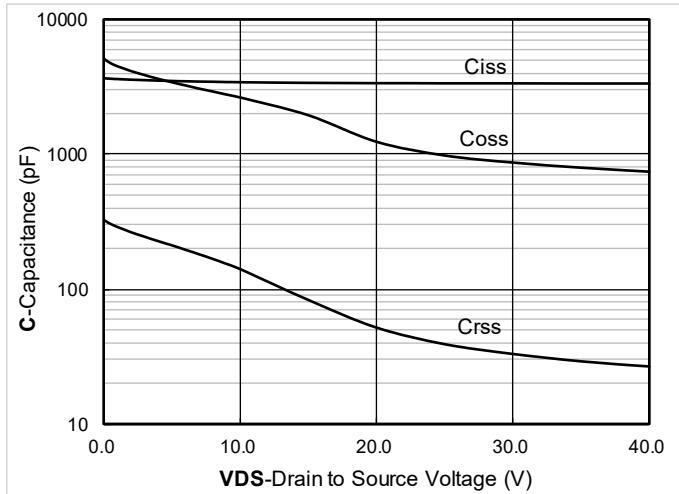


Figure 3. Capacitance Characteristics

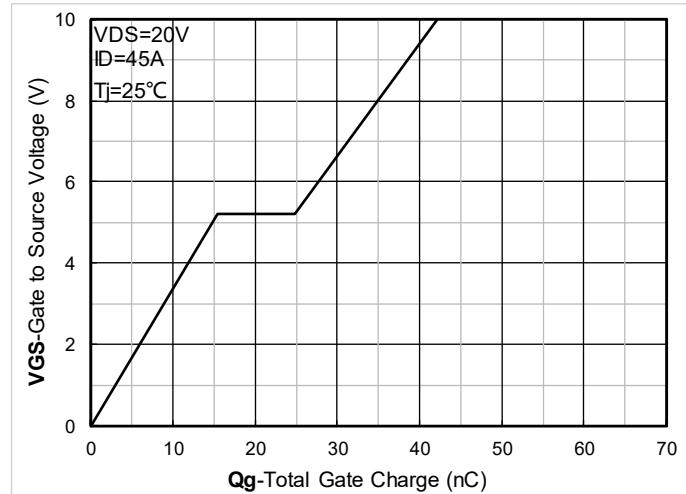


Figure 4. Gate Charge

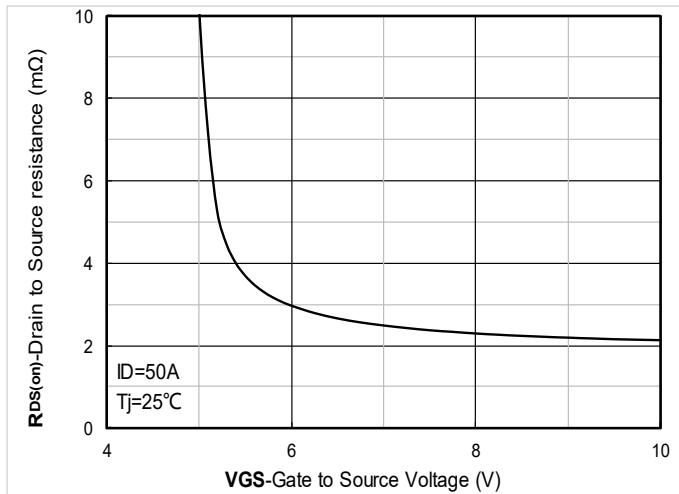


Figure 5. On-Resistance vs Gate to Source Voltage

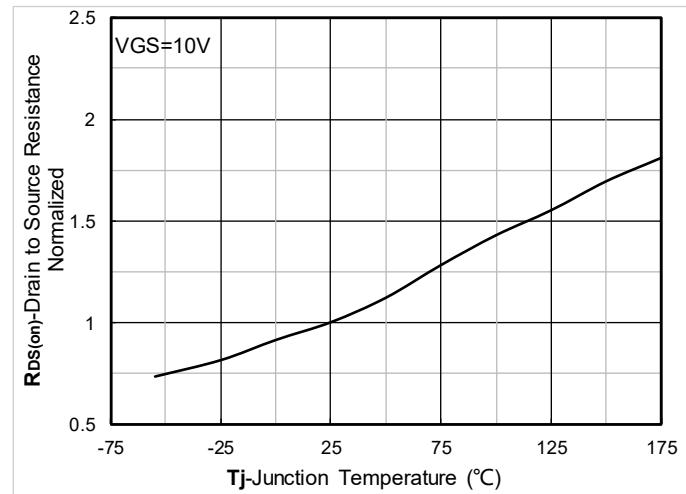


Figure 6. Normalized On-Resistance

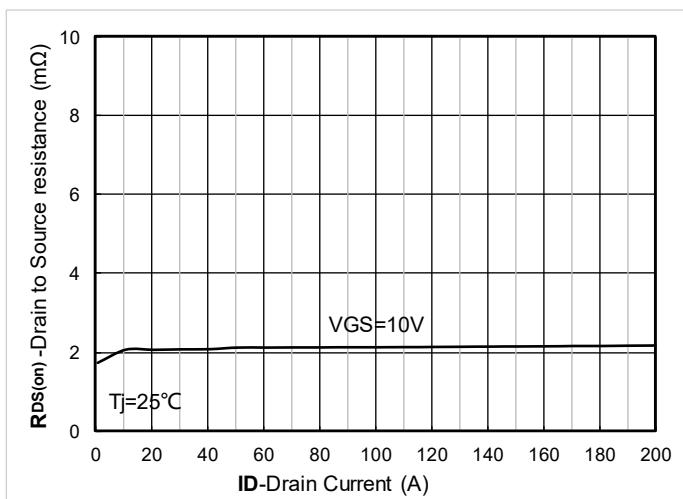


Figure 7. R<sub>D(on)</sub> VS Drain Current

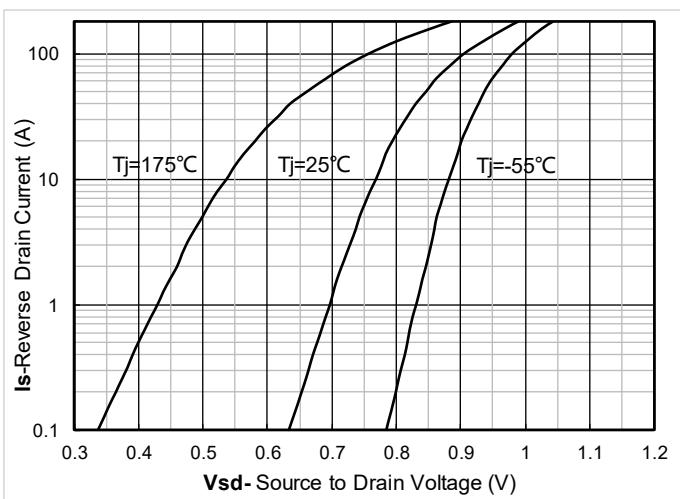


Figure 8. Forward characteristics of reverse diode

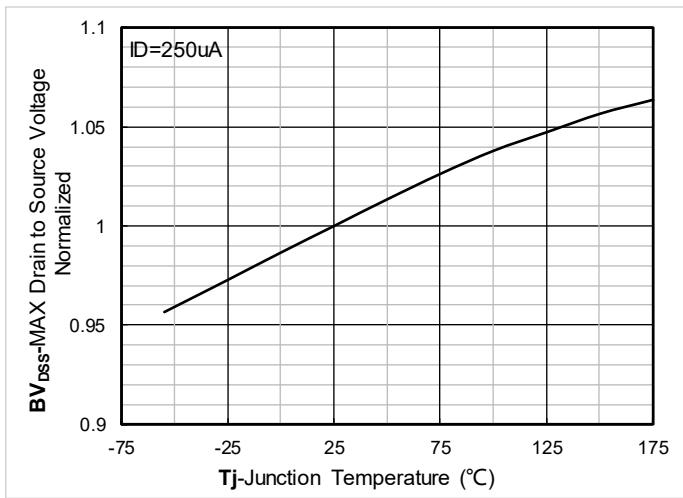


Figure 9. Normalized breakdown voltage

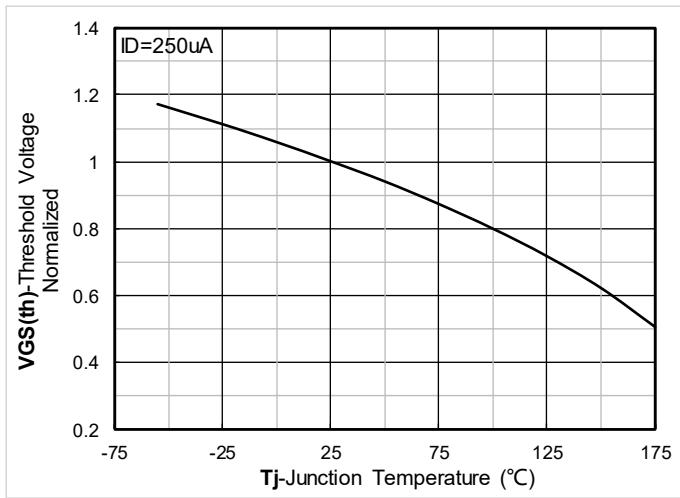


Figure 10. Normalized Threshold voltage

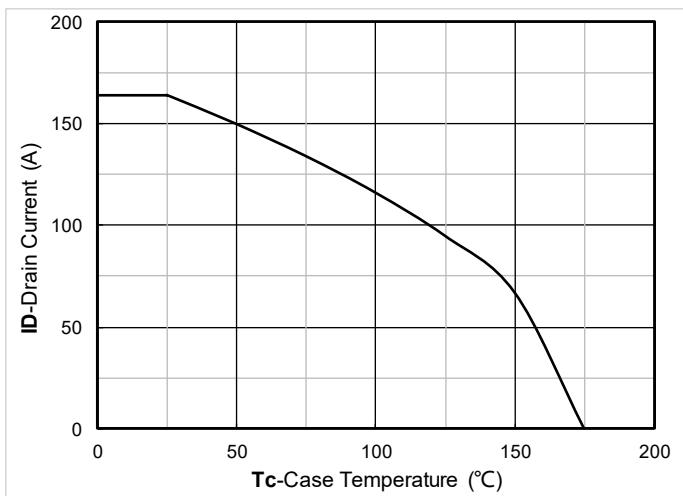


Figure 11. Current dissipation

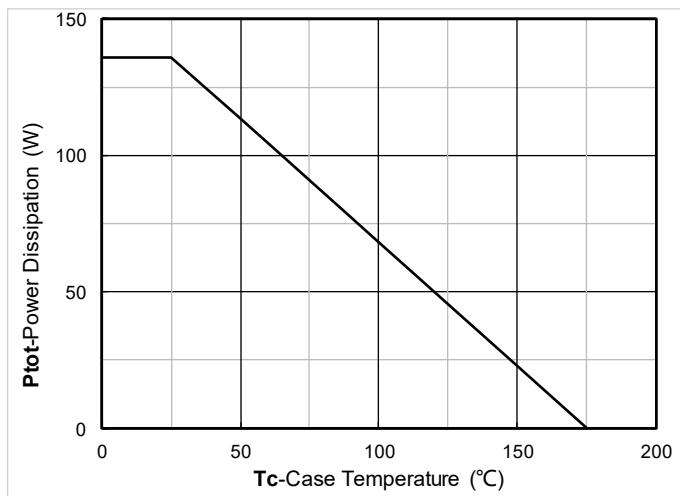


Figure 12. Power dissipation

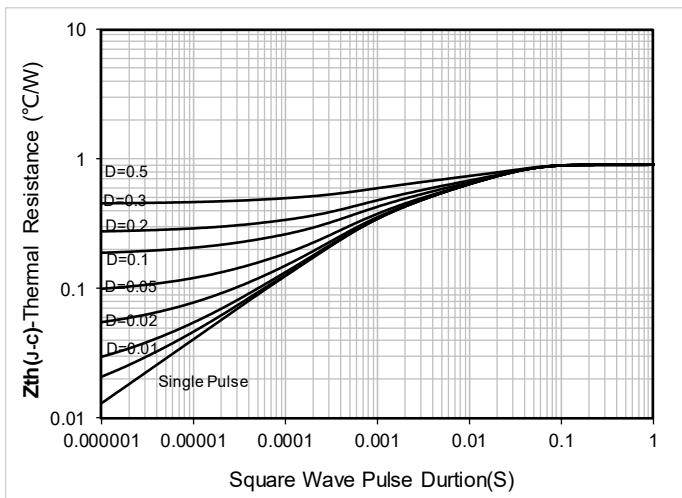


Figure 13. Maximum Transient Thermal Impedance

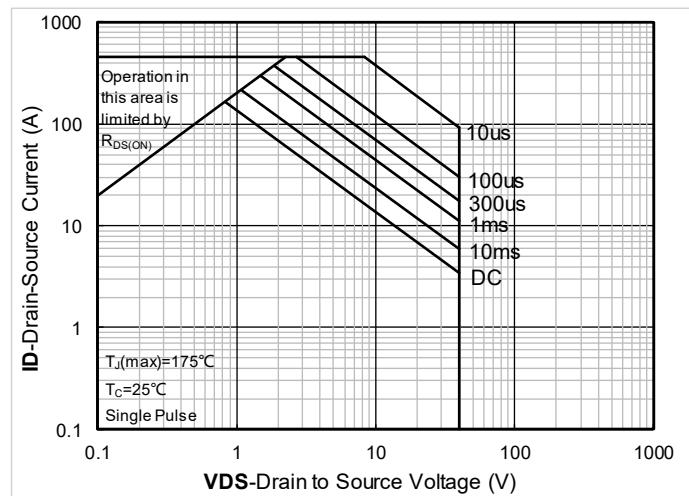
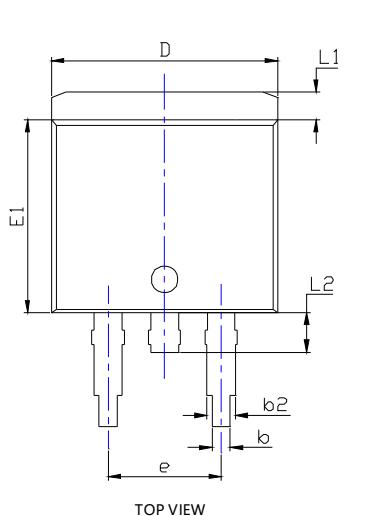


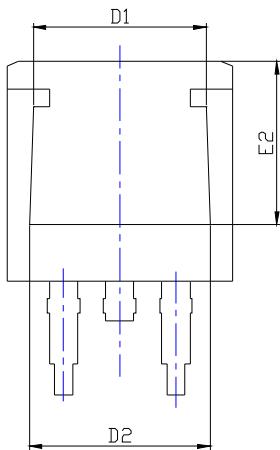
Figure 14. Safe Operation Area



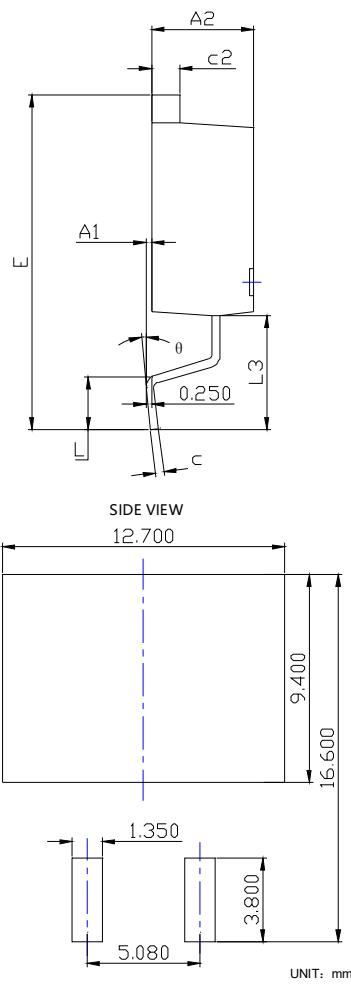
## ■ TO-263-HY Package information



TOP VIEW



BOTTOM VIEW



SUGGESTED SOLDER PAD LAYOUT

SYMBOL	INCHES			Millimeter		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A1	0.000	---	0.010	0.000	---	0.250
A2	0.174	0.180	0.186	4.430	4.580	4.730
b	0.028	0.032	0.036	0.720	0.820	0.920
b2	0.046	0.050	0.054	1.180	1.280	1.380
c	0.013	0.015	0.018	0.330	0.390	0.450
c2	0.048	0.050	0.053	1.220	1.280	1.340
D	0.394	0.400	0.406	10.000	10.150	10.300
D1	0.295	0.307	0.319	7.500	7.800	8.100
D2	0.303	0.315	0.327	7.700	8.000	8.300
E	0.571	0.591	0.610	14.500	15.000	15.500
E1	0.337	0.341	0.348	8.550	8.700	8.850
E2	0.276	0.287	0.299	7.000	7.300	7.600
e	0.200BSC			5.080BSC		
L	0.070	---	0.110	1.790	---	2.790
L1	0.044	---	0.056	1.120	---	1.420
L2	0.030	---	0.070	0.770	---	1.770
L3	0.197REF			5.000REF		
0	0°	---	8°	0°	---	8°

## NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



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